

SEMICONDUCTOR®

# FDZ663P

December 2011

# P-Channel 1.5 V Specified PowerTrench $^{\mbox{\scriptsize R}}$ Thin WL-CSP MOSFET -20 V, -2.7 A, 134 m $\Omega$

### Features

- Max  $r_{DS(on)}$  = 134 m $\Omega$  at V<sub>GS</sub> = -4.5 V, I<sub>D</sub> = -2 A
- Max  $r_{DS(on)}$  = 171 m $\Omega$  at V<sub>GS</sub> = -2.5 V, I<sub>D</sub> = -1.5 A
- Max  $r_{DS(on)}$  = 216 m $\Omega$  at V<sub>GS</sub> = -1.8 V, I<sub>D</sub> = -1 A
- Max r<sub>DS(on)</sub> = 288 mΩ at V<sub>GS</sub> = -1.5 V, I<sub>D</sub> = -1 A
- Occupies only 0.64 mm<sup>2</sup> of PCB area. Less than 16% of the area of 2 x 2 BGA
- Ultra-thin package: less than 0.4 mm height when mounted to PCB
- RoHS Compliant

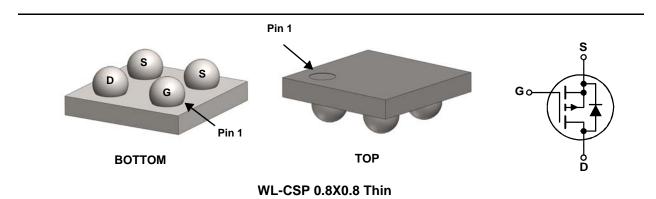


## **General Description**

Designed on Fairchild's advanced 1.5 V PowerTrench<sup>®</sup> process with state of the art "fine pitch" Thin WLCSP packaging process, the FDZ663P minimizes both PCB space and  $r_{DS(on)}$ . This advanced WLCSP MOSFET embodies a breakthrough in packaging technology which enables the device to combine excellent thermal transfer characteristics, ultra-low profile (0.4 mm) and small (0.8x0.8 mm<sup>2</sup>) packaging, low gate charge, and low  $r_{DS(on)}$ .

### Applications

- Battery management
- Load switch
- Battery protection



### MOSFET Maximum Ratings T<sub>A</sub> = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V <sub>DS</sub>	Drain to Source Voltage			-20	V	
V <sub>GS</sub>	Gate to Source Voltage			±8	V	
	-Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	-2.7	٨	
I <sub>D</sub>	-Pulsed			-10	A	
P <sub>D</sub>	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	1.3	14/	
	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1b)	0.4	W	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			-55 to +150	°C	

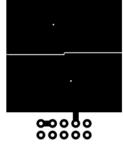
### **Thermal Characteristics**

$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	93	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient	(Note 1b)	311	C/VV

### Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
EJ	FDZ663P	WL-CSP 0.8X0.8 Thin	7 "	8 mm	5000 units

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	octeristics					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$I_D = -250 \ \mu A, V_{GS} = 0 \ V$	-20			V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu$ A, referenced to 25 °C		-14		mV/°C
IDSS	Zero Gate Voltage Drain Current	$V_{DS} = -16 \text{ V}, V_{GS} = 0 \text{ V}$			-1	μA
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 8 \text{ V},  V_{DS} = 0 \text{ V}$			±60	nA
On Chara	cteristics					
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = -250 \ \mu A$	-0.3	-0.7	-1.2	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = -250 \ \mu$ A, referenced to 25 °C		2.4		mV/°C
	Static Drain to Source On Resistance	$V_{GS} = -4.5 \text{ V}, I_D = -2 \text{ A}$		103	134	
r <sub>DS(on)</sub>		V <sub>GS</sub> = -2.5 V, I <sub>D</sub> = -1.5 A		122	171	1
		V <sub>GS</sub> = -1.8 V, I <sub>D</sub> = -1 A		149	216	mΩ
		V <sub>GS</sub> = -1.5 V, I <sub>D</sub> = -1 A		186	288	
		$V_{GS}$ = -4.5 V, $I_D$ = -2 A, $T_J$ =125°C		137	198	
9 <sub>FS</sub>	Forward Transconductance	$V_{DD} = -5 V, I_D = -2 A$		8		S
C <sub>iss</sub> C <sub>oss</sub>	Characteristics Input Capacitance Output Capacitance	− V <sub>DS</sub> = -10 V, V <sub>GS</sub> = 0 V, − f = 1 MHz		394 62	525 85	pF pF
C <sub>rss</sub>	Reverse Transfer Capacitance			53	80	pF
Switching	g Characteristics					
t <sub>d(on)</sub>	Turn-On Delay Time			4.8	10	ns
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = -10 V, I <sub>D</sub> = -2.5 A,		6.2	12	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS}$ = -4.5 V, $R_{GEN}$ = 6 $\Omega$		67	107	ns
t <sub>f</sub>	Fall Time			32	52	ns
Qg	Total Gate Charge	V 45V/V 40V/		5.9	8.2	nC
Q <sub>gs</sub>	Gate to Source Charge	──V <sub>GS</sub> = -4.5 V, V <sub>DD</sub> = -10 V, I <sub>D</sub> = -2.5 A		0.6		nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge	10 - 2.0 /		1.6		nC
Drain-Sou	urce Diode Characteristics					
V <sub>SD</sub>	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = -1.4 A$ (Note 2)		-0.8	-1.2	V
t <sub>rr</sub>	Reverse Recovery Time			30	48	ns
Q <sub>rr</sub>	Reverse Recovery Charge	I <sub>F</sub> = -2.5 A, di/dt = 100 A/μs		10	18	nC



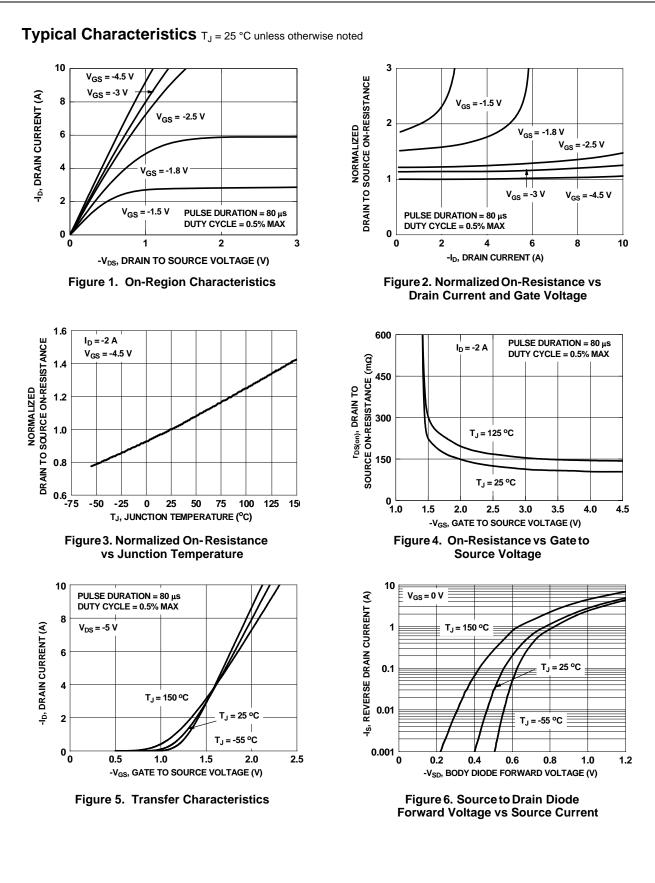
2. Pulse Test: Pulse Width < 300  $\mu$ s, Duty cycle < 2.0%.

ad of 2 oz copper.



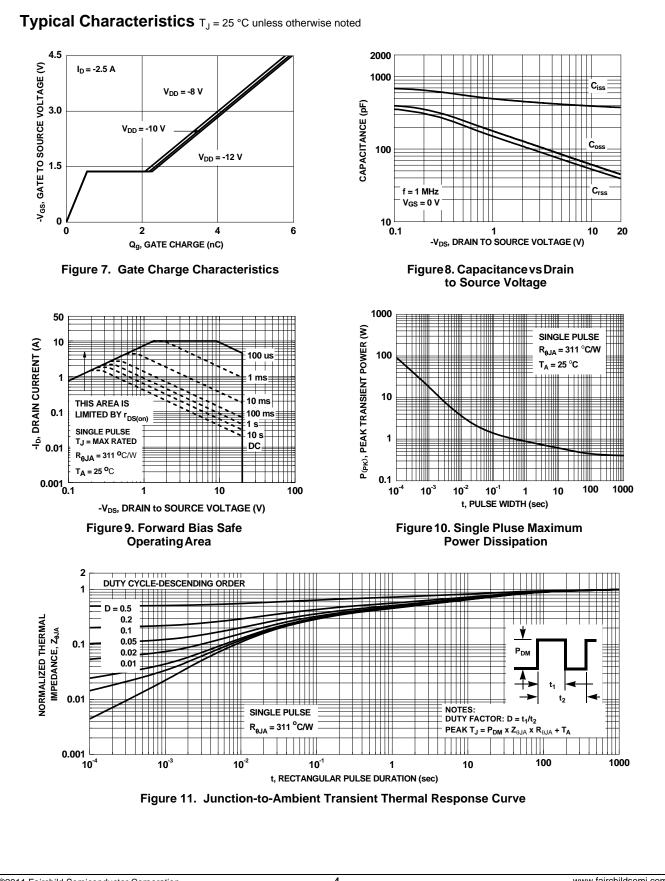
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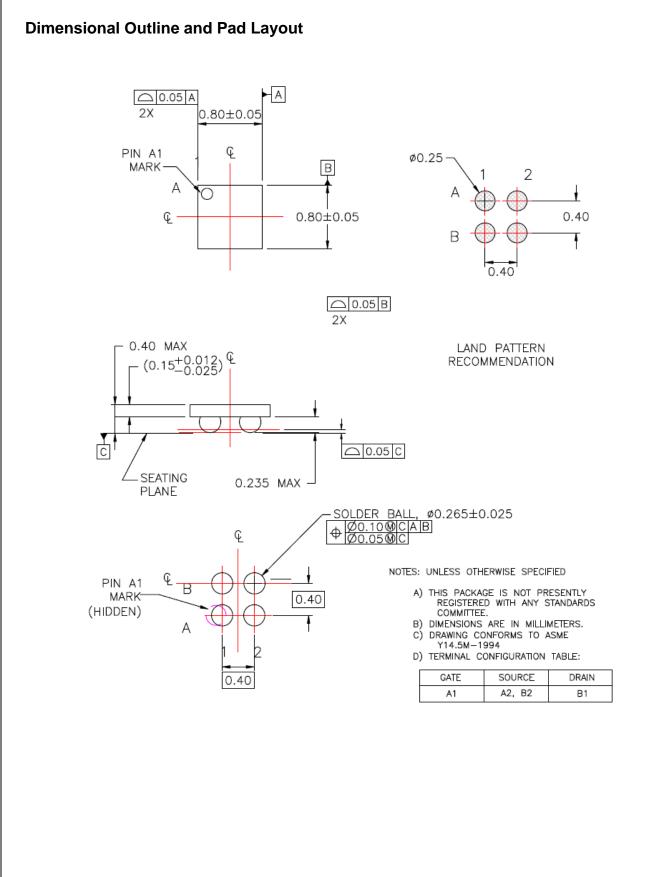


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FDZ663P P-Channel 1.5 V Specified PowerTrench<sup>®</sup> Thin WL-CSP MOSFET





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